Triple buffer Rev. 13 — 26 October 2018

### 1. General description

The 74LVC3G34 provides three buffers.

The inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of the 74LVC3G34 as a translator in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- $\pm$ 24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



**Triple buffer** 

## 3. Ordering information

### Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC3G34DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2
74LVC3G34DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1
74LVC3G34GT	-40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	SOT833-1
74LVC3G34GF	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1 × 0.5 mm	SOT1089
74LVC3G34GM	-40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 × 1.6 × 0.5 mm	SOT902-2
74LVC3G34GN	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm	SOT1116
74LVC3G34GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	SOT1203

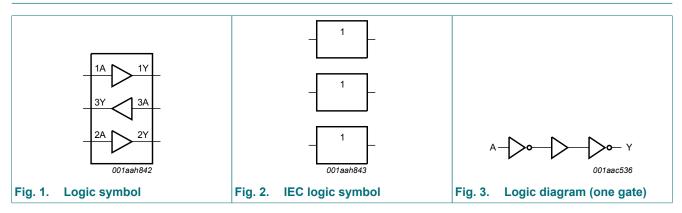
## 4. Marking

### Table 2. Marking codes

Type number	Marking code [1]
74LVC3G34DP	V34
74LVC3G34DC	Y34
74LVC3G34GT	Y34
74LVC3G34GF	YA
74LVC3G34GM	Y34
74LVC3G34GN	YA
74LVC3G34GS	YA

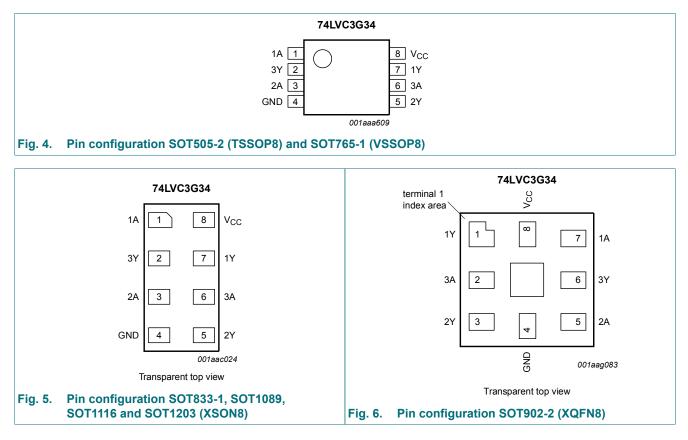
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 5. Functional diagram



## 6. Pinning information

6.1. Pinning



### 6.2. Pin description

Table 3. Pin des	cription			
Symbol	Pin	Pin		
	SOT505-2, SOT765-1, SOT833-1, SOT1089, SOT1116 and SOT1203	SOT902-2		
1A, 2A, 3A	1, 3, 6	7, 5, 2	data input	
1Y, 2Y, 3Y	7, 5, 2	1, 3, 6	data output	
GND	4	4	ground (0 V)	
V <sub>CC</sub>	8	8	supply voltage	

## 7. Functional description

### Table 4. Function table

*H* = *HIGH* voltage level; *L* = *LOW* voltage level.

Input nA	Output nY
L	L
Н	Н

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+6.5	V
l <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V		-	±50	mA
Vo	output voltage	Active mode	[1]	-0.5	V <sub>CC</sub> + 0.5	V
		Power-down mode; $V_{CC}$ = 0 V	[1]	-0.5	+6.5	V
I <sub>O</sub>	output current	$V_{O} = 0 V \text{ to } V_{CC}$		-	±50	mA
I <sub>CC</sub>	supply current			-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	250	mW
T <sub>stg</sub>	storage temperature			-65	+150	°C

The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 For TSSOP8 package: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K.

[2] For TSSOP8 package: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K. For VSSOP8 package: above 110 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K.

For XSON8, XQFN8 packages: above 118  $^\circ\text{C}$  the value of P\_tot derates linearly with 7.8 mW/K.

## 9. Recommended operating conditions

### Table 6. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V
		Power-down mode; $V_{CC}$ = 0 V	0	5.5	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	-	20	ns/V
		V <sub>CC</sub> = 2.7 V to 5.5 V	-	10	ns/V

## **10. Static characteristics**

#### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> =	-40 °C to	+85 °C	T <sub>an</sub> -40 °C to	<sub>ль</sub> = +125 °С	Unit
			Min Typ [1] Max		Max			
VIH	HIGH-level input	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	V
	voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.7V <sub>CC</sub>	-	-	0.7V <sub>CC</sub>	-	V
VIL	LOW-level input	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35V <sub>CC</sub>	-	0.35V <sub>CC</sub>	V
	voltage	V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.3V <sub>CC</sub>	-	0.3V <sub>CC</sub>	V
V <sub>OH</sub>	HIGH-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 5.5 V	V <sub>CC</sub> - 0.1	-	-	V <sub>CC</sub> - 0.1	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V	1.2	-	-	0.95	-	V
		I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V	1.9	-	-	1.7	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	2.2	-	-	1.9	-	V
		I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V	2.3	-	-	2.0	-	V
		I <sub>O</sub> = -32 mA; V <sub>CC</sub> = 4.5 V	3.8	-	-	3.4	-	V
V <sub>OL</sub>	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 5.5 V	-	-	0.1	-	0.1	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.45	-	0.7	V
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	-	0.3	-	0.45	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.4	-	0.6	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.55	-	0.8	V
		I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V	-	-	0.55	-	0.8	V
I	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	±0.1	±1	-	±1	μA
OFF	power-off leakage current	$V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	±0.1	±2	-	±2	μA
сс	supply current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A	-	0.1	4	-	4	μA
∆I <sub>CC</sub>	additional supply current	per pin; $V_{CC}$ = 2.3 V to 5.5 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A	-	5	500	-	500	μA
CI	input capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = GND to $V_{CC}$	-	2.5	-	-	-	pF

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

## **11. Dynamic characteristics**

### **Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.

Symbol	Parameter	Conditions	T <sub>amb</sub> =	= -40 °C to	+85 °C		<sub>nb</sub> = • +125 °C	Unit ns ns
		-	Min	Typ [1]	Max	Min	Мах	
t <sub>pd</sub>	propagation delay	nA to nY; see Fig. 7 [2]						
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.0	3.8	8.6	1.0	10.8	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.5	2.4	4.4	0.5	5.5	ns
		V <sub>CC</sub> = 2.7 V	0.5	2.5	5.0	0.5	6.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.5	2.2	4.1	0.5	5.1	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.5	1.9	3.2	0.5	4.0	ns
C <sub>PD</sub>	power dissipation capacitance	$V_1 = GND$ to $V_{CC}$ ; $V_{CC} = 3.3 V$ [3]	-	14	-	-	-	pF

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[1] Typical values are increasing a simple and  $t_{PLL}$ [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ . [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

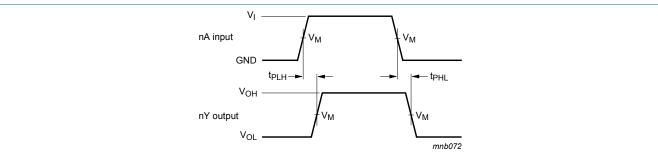
 $f_o$  = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;  $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$ 

### 11.1. Waveforms and test circuit



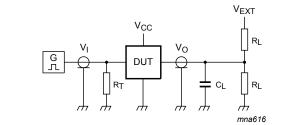
Measurement points are given in <u>Table 9</u>.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

### Fig. 7. The data input (nA) to output (nY) propagation delays

#### Table 9. Measurement points

Supply voltage	Input	Output	
V <sub>cc</sub>	V <sub>M</sub>	V <sub>M</sub>	
1.65 V to 1.95 V	0.5 × V <sub>CC</sub>	$0.5 \times V_{CC}$	
2.3 V to 2.7 V	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>	
2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	1.5 V	1.5 V	
4.5 V to 5.5 V	0.5 × V <sub>CC</sub>	$0.5 \times V_{CC}$	



Test data is given in Table 10.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

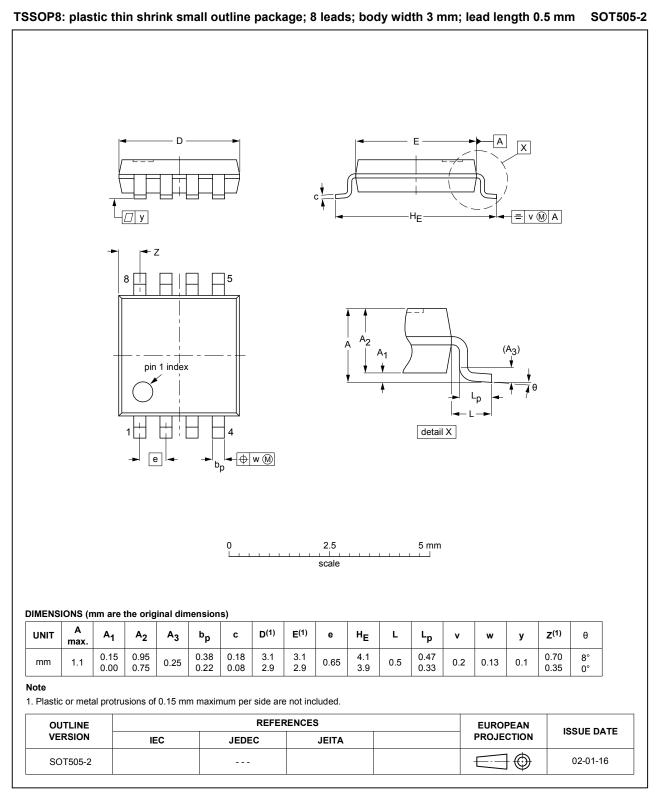
 $V_{EXT}$  = External voltage for measuring switching times.

### Fig. 8. Test circuit for measuring switching times

Supply voltage	voltage Input Load		Load		Load           t <sub>r</sub> = t <sub>f</sub> C <sub>L</sub> R <sub>L</sub>		V <sub>EXT</sub>
V <sub>cc</sub>	VI	t <sub>r</sub> = t <sub>f</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>				
1.65 V to 1.95 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	1 kΩ	open		
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	500 Ω	open		
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open		
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open		
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	open		

74LVC3G34

## 12. Package outline



### Fig. 9. Package outline SOT505-2 (TSSOP8)

74LVC3G34

### **Triple buffer**

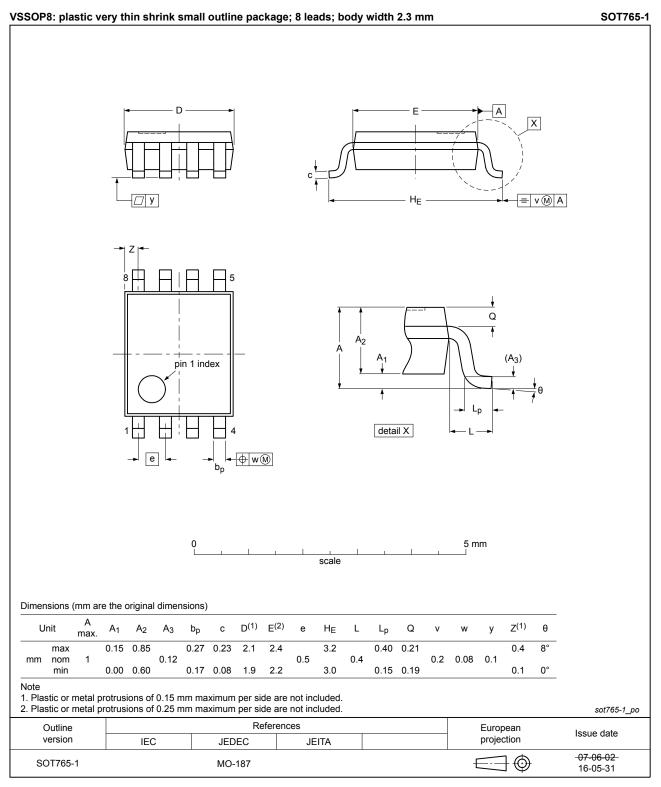


Fig. 10. Package outline SOT765-1 (VSSOP8)

### **Triple buffer**

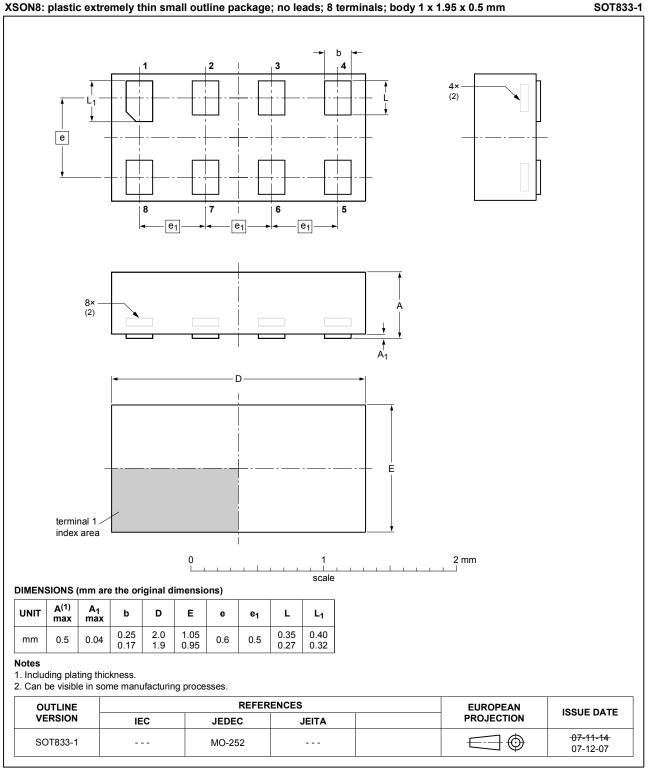


Fig. 11. Package outline SOT833-1 (XSON8)

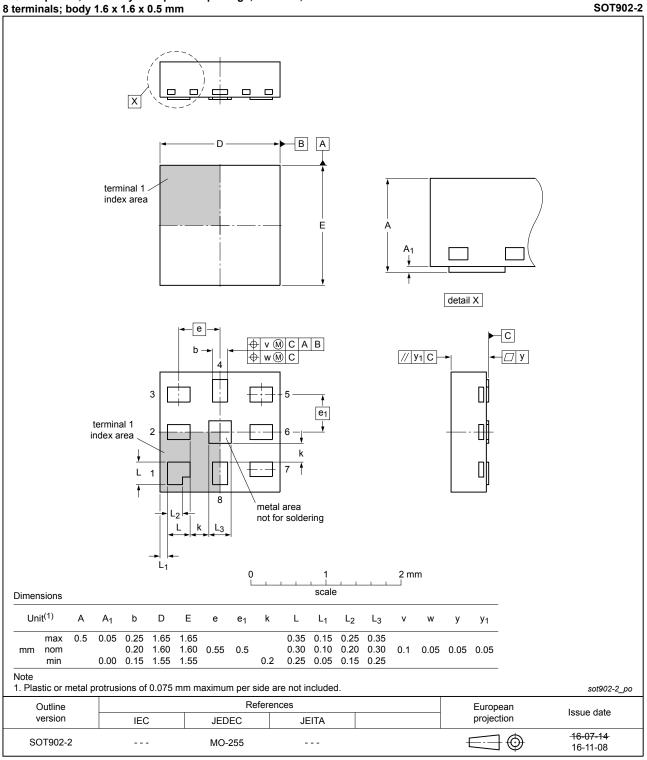
### **Triple buffer**

terminals; body 1	thin small outline package; no leads; .35 x 1 x 0.5 mm	SOT10
	terminal 1 index area	
Dimensions	terminal 1 index area 0 0.5 1 mm scale	
Unit A <sup>(1)</sup>	A <sub>1</sub> b D E e e <sub>1</sub> L L <sub>1</sub>	
max 0.5 ( mm nom min	0.04         0.20         1.40         1.05         0.35         0.40           0.15         1.35         1.00         0.55         0.35         0.30         0.35           0.12         1.30         0.95         0.27         0.32	
Note 1. Including plating th	ickness.	
2. Visible depending Outline	upon used manufacturing technology.  References European	sot1089_p
version	IEC JEDEC JEITA projection	Issue date
	I I I I	10-04-09

## XSON8: extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1 \times 0.5 \text{ mm}$

Fig. 12. Package outline SOT1089 (XSON8)

### **Triple buffer**



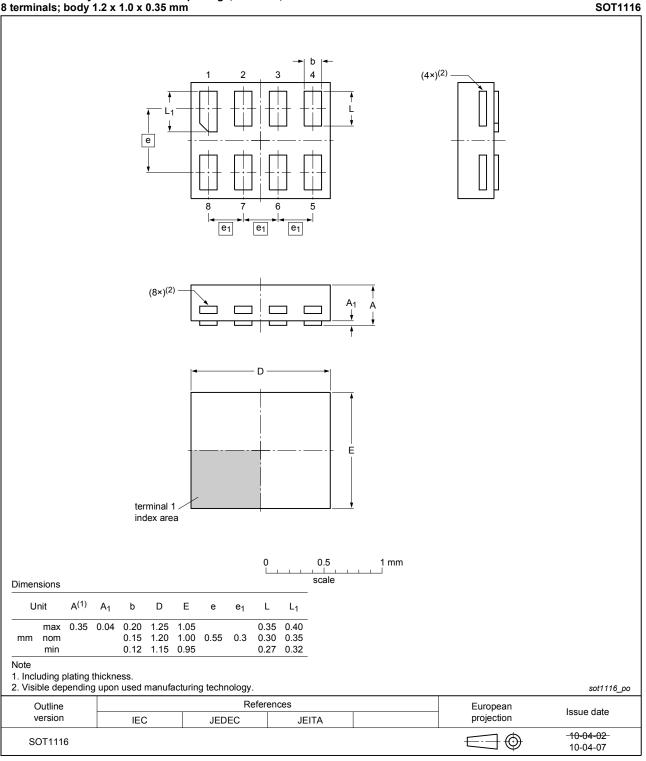
#### XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm

Fig. 13. Package outline SOT902-2 (XQFN8)

**Product data sheet** 

### **Triple buffer**

#### XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm





### **Triple buffer**

erminals; body	1.35 x 1.0 x 0.35 mm	SOT12
	$\begin{array}{c} \bullet & \bullet & \bullet \\ & \bullet & \bullet \\ & \bullet & \bullet \\ & \bullet & \bullet$	
	terminal 1 index area	
Dimensions	0 0.5 1 mm scale	
	A1         b         D         E         e         e1         L         L1           0.04         0.20         1.40         1.05         0.35         0.40           0.15         1.35         1.00         0.55         0.35         0.30           0.12         1.30         0.95         0.27         0.32	
lote . Including plating		sot1203_µ
Outline	References European	Issue date
version	IEC JEDEC JEITA projection	-10-04-02

Fig. 15. Package outline SOT1203 (XSON8)

## 13. Abbreviations

Table 11. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

## 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC3G34 v.13	20181026	Product data sheet	-	74LVC3G34 v.12		
Modifications:	of Nexperia. <ul> <li>Legal texts</li> </ul>	Legar texts have been adapted to the new company name where appropriate.				
74LVC3G34 v.12	20161215	Product data sheet	-	74LVC3G34 v.11		
Modifications:	• <u>Table 7</u> : The	• <u>Table 7</u> : The maximum limits for leakage current and supply current have changed.				
74LVC3G34 v.11	20130402	Product data sheet	-	74LVC3G34 v.10		
Modifications:	For type nur	For type number 74LVC3G34GD XSON8U has changed to XSON8.				
74LVC3G34 v.10	20120808	Product data sheet	-	74LVC3G34 v.9		
Modifications:	For type nur	For type number 74LVC3G34GM the SOT code has changed to SOT902-2.				
74LVC3G34 v.9	20111123	Product data sheet	-	74LVC3G34 v.8		
Modifications:	Legal pages	Legal pages updated.				
74LVC3G34 v.8	20100902	Product data sheet	-	74LVC3G34 v.7		
74LVC3G34 v.7	20080509	Product data sheet	-	74LVC3G34 v.6		
74LVC3G34 v.6	20080312	Product data sheet	-	74LVC3G34 v.5		
74LVC3G34 v.5	20071005	Product data sheet	-	74LVC3G34 v.4		
74LVC3G34 v.4	20070302	Product data sheet	-	74LVC3G34 v.3		
74LVC3G34 v.3	20050131	Product data sheet	-	74LVC3G34 v.2		
74LVC3G34 v.2	20041027	Product data sheet	-	74LVC3G34 v.1		
74LVC3G34 v.1	20040429	Product data sheet	-	-		

#### **Triple buffer**

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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### **Triple buffer**

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